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UniFET[™]

SEMICONDUCTOR® **FDA79N15**

FAIRCHILD

150V N-Channel MOSFET

Features

- 79A, 150V, $R_{DS(on)} = 0.03\Omega @V_{GS} = 10 V$
- Low gate charge (typical 56 nC)
- Low C_{rss} (typical 96 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

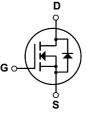
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



FDA Series



Absolute Maximum Ratings

Symbol		Parameter		FDA79N15	Unit
V _{DSS}	Drain-Source Voltage		150	V	
ID		- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		79 50	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	316	A
V _{GSS}	Gate-Source voltage			±30	V
E _{AS}	Single Pulsed Avalanch	ne Energy	(Note 2)	1669	mJ
I _{AR}	Avalanche Current		(Note 1)	79	A
E _{AR}	Repetitive Avalanche Energy (Note		(Note 1)	41.7	mJ
dv/dt	Peak Diode Recovery	dv/dt	(Note 3)	4.5	V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C			417 3.3	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	٥C
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		9,	300	°C

Thermal Characteristics

Symbol	Parameter	Min.	Max.	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case		0.3	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.24		°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient		40	°C/W

Size	Тар	e Width			Quantity			
	-			30				
ons		Min.	Т	yp.	Max	Units		
		150				V		
d to 25°C			0.	.15		V/°C		
°C					1 10	μΑ μΑ		
					100	nA		
					-100	nA		
١		3.0			5.0	V		
			0.	025	0.03	Ω		
	(Note 4)		4	16		S		
			•		•	•		
			26	620	3410	pF		
			7	30	950	pF		

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDA79N15	FDA79N15	TO-3PN	-	-	30

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
Off Charac	teristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	150			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C		0.15		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 150V, V_{GS} = 0V V_{DS} = 120V, T_{C} = 125°C			1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V			-100	nA
On Charac	teristics				•	•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 39.5A		0.025	0.03	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40V, I _D = 39.5A (Note 4)		46		S
Dynamic C	Characteristics				•	•
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V,		2620	3410	рF
C _{oss}	Output Capacitance	f = 1.0MHz		730	950	pF
C _{rss}	Reverse Transfer Capacitance			96	140	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 75V, I _D = 79A		50	112	ns
t _r	Turn-On Rise Time	$R_{G} = 25\Omega$		200	410	ns
t _{d(off)}	Turn-Off Delay Time			55	120	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		38	85	ns
Qg	Total Gate Charge	V _{DS} = 120V, I _D = 79A		56	73	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10V		18		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		21		nC
Drain-Sour	rce Diode Characteristics and Maximur	n Ratings				
I _S	Maximum Continuous Drain-Source Dio	de Forward Current			79	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				316	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 79A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 79A		136		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt =100Å/μs (Note 4)		2.1		μC

NOTES:

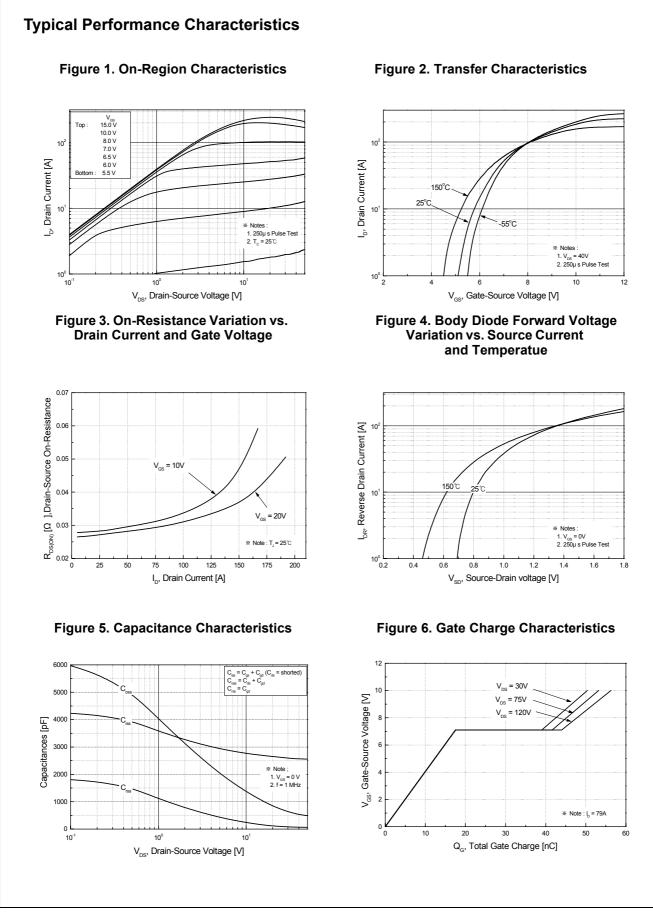
1. Repetitive Rating: Pulse width limited by maximum junction temperature

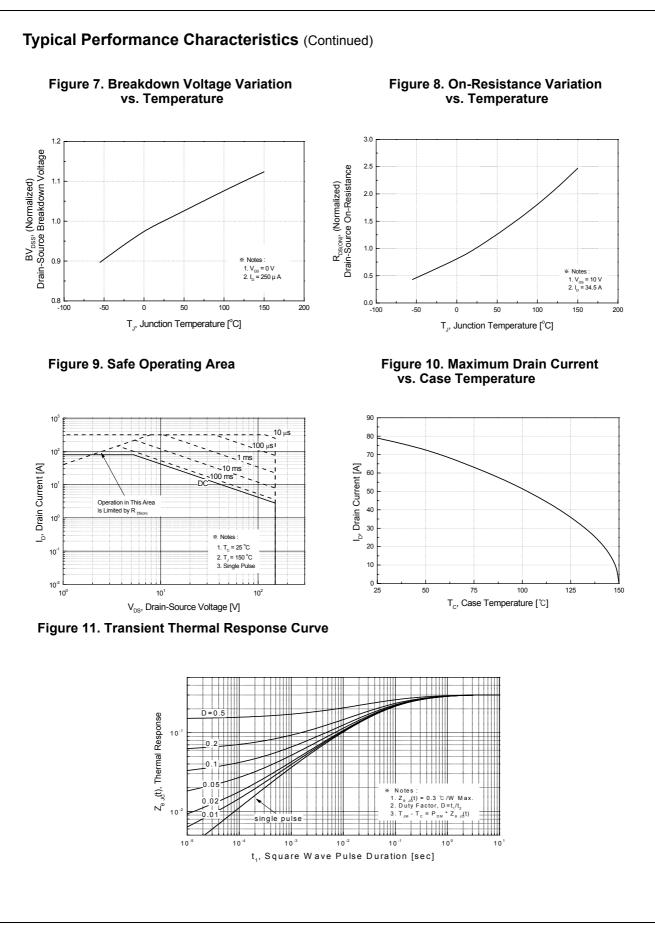
2. L = 0.357mH, I_{AS} = 79A, V_DD = 50V, R_G = 25 Ω , Starting T_J = 25°C

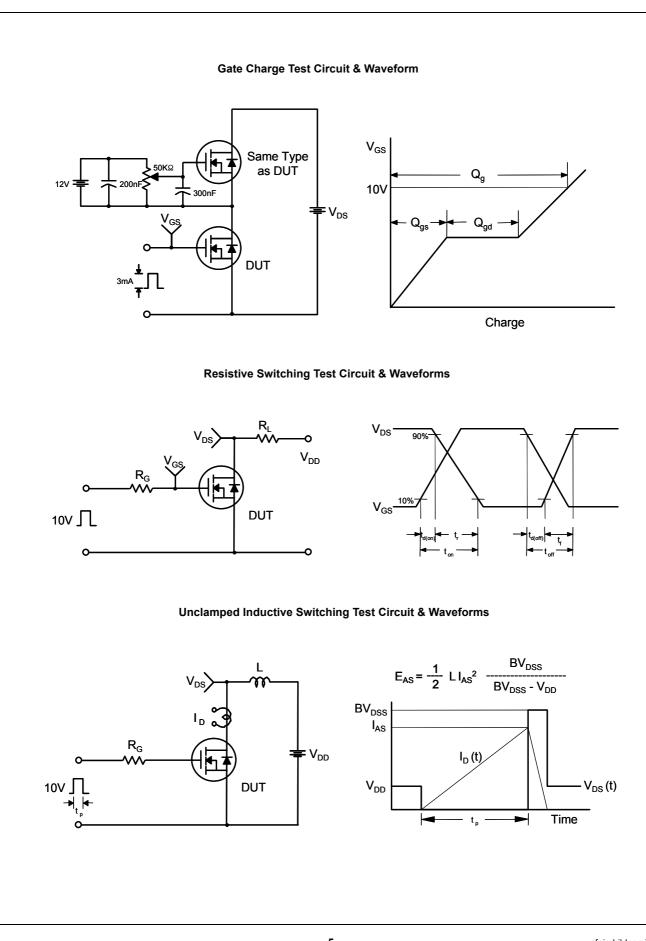
3. I_{SD} \leq 79A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

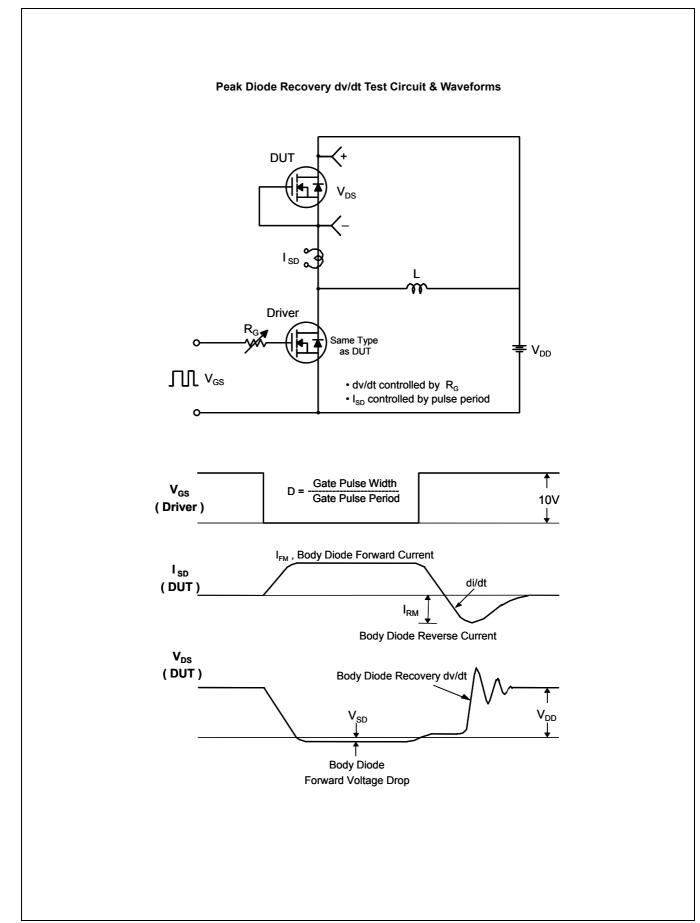
4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

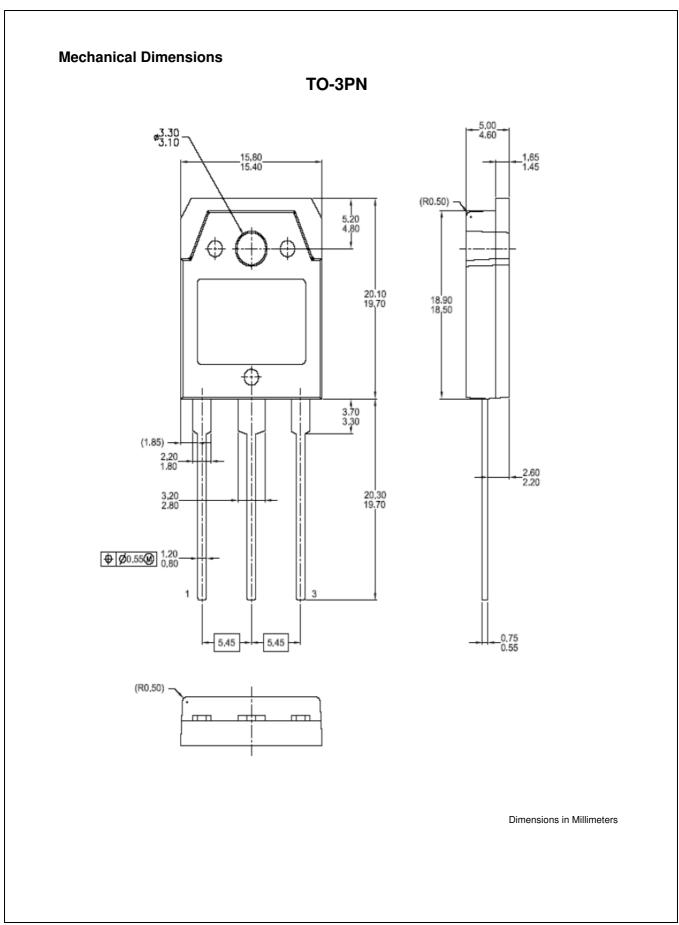
5. Essentially Independent of Operating Temperature Typical Characteristics











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E ² CMOS [™]	<i>i-Lo</i> ™	OCX [™]	µSerDes [™]	UltraFET [®]
EnSigna [™]	ImpliedDisconnect™	OCX [™]	ScalarPump [™]	UniFET [™]
EnSigna™	ImpliedDisconnect™	OCXPro™	ScalarPump™	UniFEI™
FACT™	IntelliMAX™	OPTOLOGIC [®]	SILENT SWITCHER [®]	VCX™
FACT Quiet Serie		OPTOPLANAR™	SMART START™	Wire™
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
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